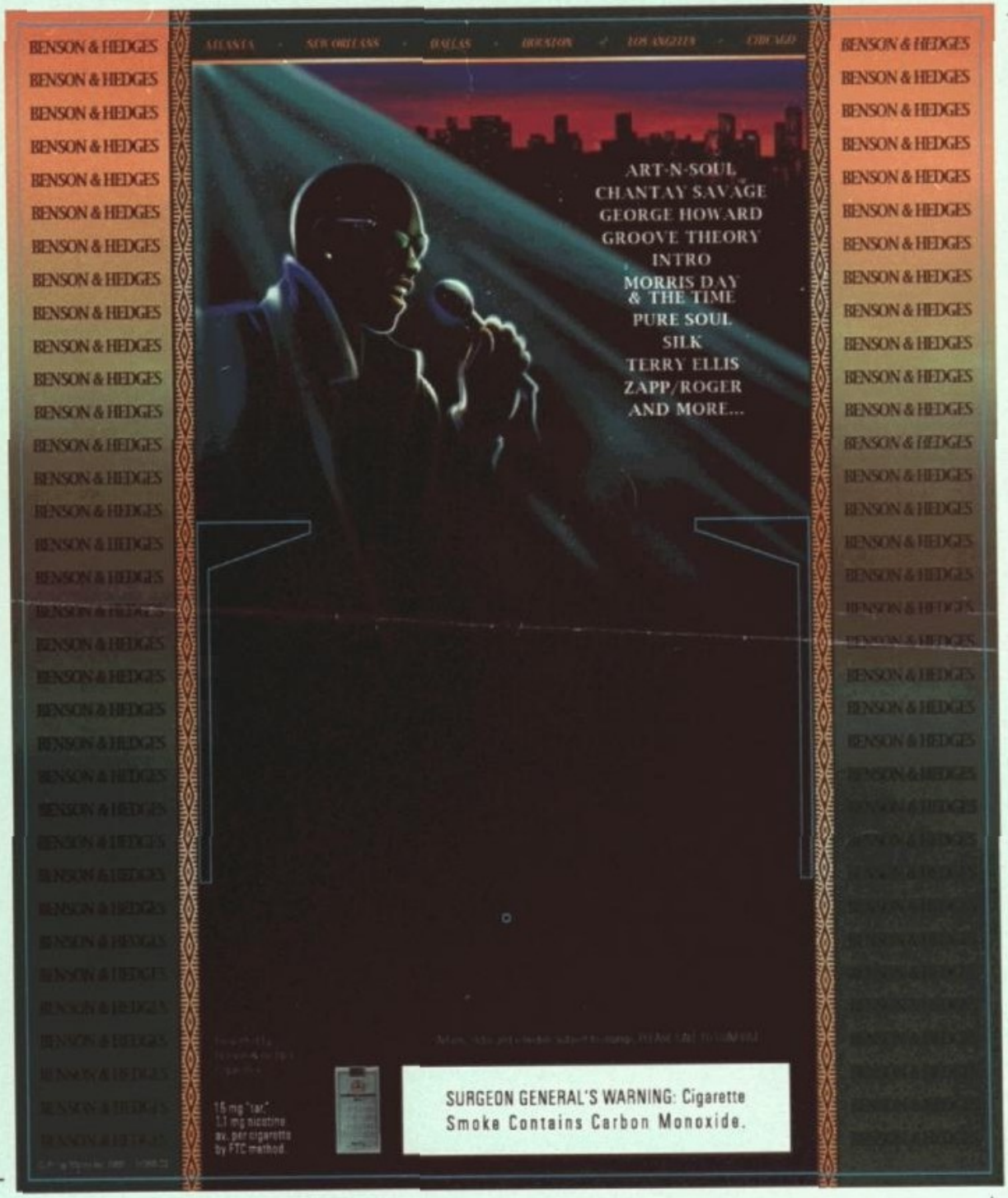
Source: https://www.industrydocuments.ucsf.edu/docs/hhdp0003



2061038967